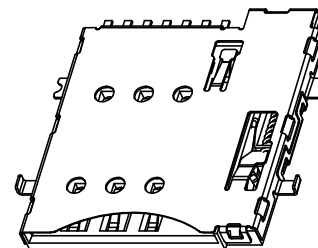
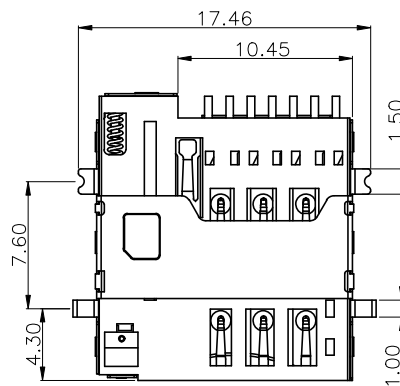
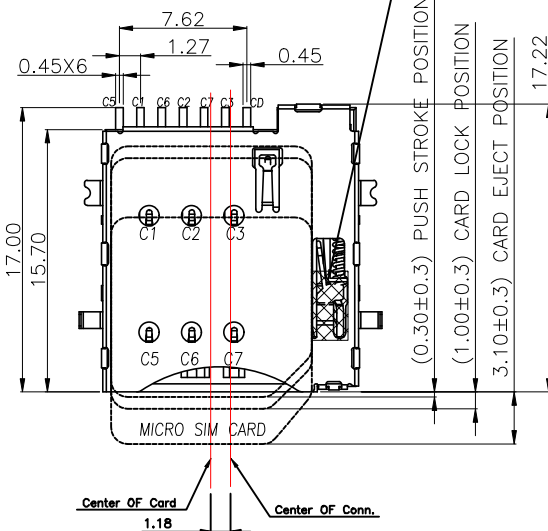


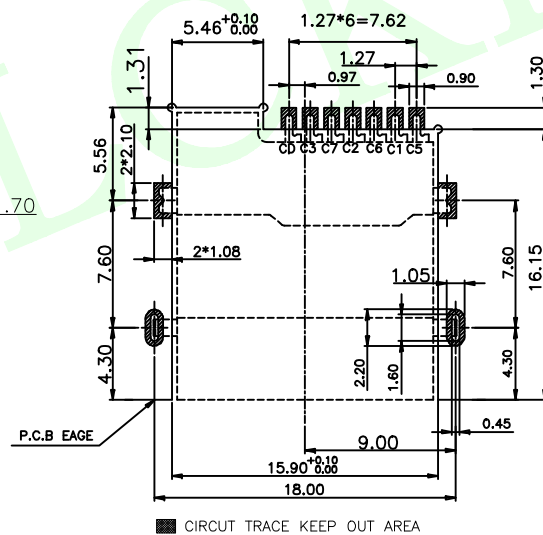
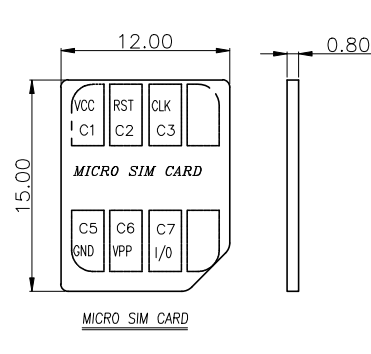
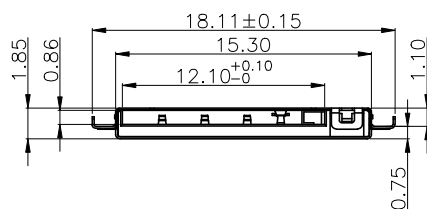
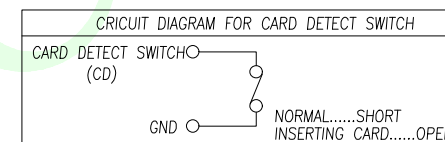
RoHS Compliant

THERE IS NO APPLY THE LAND
ON THIS AREA BY THE CASE



SIM pin Assignment	
PIN#	Name
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O

- 1) MATERIAL:
 - 1.1 HOUSING: LCP, UL94-V0, COLOR: BLACK
 - 1.2 CONTACT: C5210-EH
 - 1.3 SHELL: SUS304-H
- 2) FINISH:
 - 2.1 TERMINAL: 50 μm Min. NICKEL PLATED OVERALL
 - 2.2 CONTACT: GOLD FLASH PLATED ON CONTACT AREA; GOLD FLASH PLATED ON SOLDER TAILS;
- 3) ELECTRICAL CHARACTERISTICS
 - RATING CURRENT : 0.5A MAX.
 - CONTACT RESISTANCE : 30 mΩ MAX
 - DIELECTRIC WITHSTANDING : 500V AC MIN.
 - INSULATION RESISTANCE: 1000 MΩ MIN.
- 4) MECHANICAL CHARACTERISTICS
 - MATING CYCLE : 3000 CYCLES
 - Contact retention force: 50gf/pin Min.



■ CIRCUIT TRACE KEEP OUT AREA
■ SMT SOLDER AREA
THERE SHOULD NOT BE ANY CIRCUITS
IN THE LAYOUT SPACE OF THE PRODUCTS.
RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ±0.05

LCK-SIM-004 P7 H170-W L G

连晟欣
LCK
产品类别
MS: MINI SIM
SIM: MICRO SIM
NANO: NANO SIM
产品流水料号识别码

电镀规格
G: gold flash
G1: 1U
G3: 3U
(以此类推)

包装方式
L: 圆盘

有柱无柱
Y: 有柱
W: 无柱

产品PIN位
P7: 7PIN

产品高度
H150: 1.50MM

MEASURE POINT:
QUADRANT POINT (QP)
TANGENCY POINT (TP)
INTERSECTION POINT (IP)

UNLESS OTHERWISE
SPECIFIED, TOLERANCE:
X. ±0.25
X.x ±0.20
X.xx ±0.15
ANGULAR ±3°

					联晟欣连接器（深圳）有限公司				
					Lianshengxin Connector (Shenzhen) Co., Ltd				
DESIGN		Andy		DATE		2014.12.24		TITLE: MICRO SIM CARD PUSH PUSH 6+1PIN 带CD PIN沉板1.1	
CHECKED				DATE					
APPROVED				DATE					
PART NO: LCK-SIM-004P7H170-WLG				REV: 04		SCALE: 1:1		UNIT: mm	
DRAWING NO: 102022200S				SIZE: A4		SHEET: 1/1			

TITLE:
MICRO SIM CARD PUSH PUSH 6+1PIN
带CD PIN沉板1.1